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FACSIMILE TRANSMISSION

DATE:

10, 9, 2007

TO (FIRM):

U.S.P.T.O

ATTN:

Mr. Anthony Smith

FAX NO:

571-273-0459

FROM:

Mr. Mark J. Henry

RE:

U.S. Patent App. No. 10/556,912

YOUR REF:

OUR DOCKET NO:

1806.7012

NO. OF PAGES INCLUDING THE COVER SHEET:

5

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COMMENTS:

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VIA FACSIMILE

October 9, 2007

Attn: Mr. Anthony Smith

Re: U.S. Patent Application
 Serial No.: 10/556,912
 For: HYDROGENATED COPOLYMER-CONTAINING LAMINATE
 Inventor(s): Masahiro SASAGAWA, et al.
 Your Reference: 104-1005-US
 Our Docket: 1806.1012

Dear Mr. Smith:

Thank you for your recent telephone inquiry regarding the above-referenced case.

The application and executed Declaration were filed on June 27, 2006. We are enclosing for your review a copy of the stamped filing postcard and a copy of the Declaration.

If we can be any further assistance in rectifying this matter please feel free to contact us.

Best regards.

Very truly yours,

Mark J. Henry

MJH:tih
 Enclosure:

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Please Date Stamp and return

RESPONSE TO NOTIFICATION OF MISSING REQUIREMENTS, COPY OF NOTIFICATION OF MISSING REQUIREMENTS, COPY OF EXECUTED DECLARATION, RECORDATION FORM COVER SHEET FORM PTO-1595, COPY OF EXECUTED ASSIGNMENT AND CHECKS FOR \$130.00 AND \$40.00

APPLICANT(S): Masahiro SASAGAWA, et al.

SERIAL NO: 10/556,912

CONFIRMATION NO. 1640

TITLE: HYDROGENATED COPOLYMER-CONTAINING LAMINATE

FILING DATE: November 15, 2005

DOCKET NO: 1806.1012/M7H:nml

DUE DATE:



528

Form (Rev. 2/01)

UNITED STATES

Docket No.:

COMBINED DECLARATION/POWER OF ATTORNEY FOR UTILITY/DESIGN PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

Hydrogenated copolymer-containing laminate the specification of which is attached hereto, unless the following box is checked:☒ was filed on May 14, 2004 as United States Application Number or PCT International Application Number PCT/JP2004/008890 and was amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 C.F.R. § 1.56.

I hereby claim foreign priority benefit(s) under 35 U.S.C. ' 119(a)-(d) or ' 365(a)-(c) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application(s) for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

Prior Foreign Application(s)

Priority NOT
Claimed

<u>2003-136920</u> (Number)	<u>Japan</u> (Country)	<u>15/May/2003</u> Day/Month/Year Filed	<input type="checkbox"/>
<u>2003-136665</u> (Number)	<u>Japan</u> (Country)	<u>15/May/2003</u> Day/Month/Year Filed	<input type="checkbox"/>
<u>2003-319149</u> (Number)	<u>Japan</u> (Country)	<u>11/September/2003</u> Day/Month/Year Filed	<input type="checkbox"/>

I hereby claim the benefit under 35 U.S.C. ' 120 or ' 119(e) of any United States application(s), or ' 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application(s) in the manner provided by the first paragraph of 35 U.S.C. ' 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 C.F.R. ' 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.

(Application Serial No.)

(Filing Date)

(Status -- patented, pending, abandoned)

(Application Serial No.)

(Filing Date)

(Status -- patented, pending, abandoned)

I hereby appoint the attorneys and agents of Staas & Halsey LLP under USPTO Customer No. 21,171 to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

21171
PATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor Masahiro SASAGAWA

Inventor's Signature

Masahiro Sasagawa

Date

November 25, 2005Residence Yokohama-shi, Kanagawa-ken, JAPAN

Citizenship

JapaneseMailing Address 6-15, Katabuki, Kanazawa-ku, Yokohama-shi, Kanagawa-ken 236-0055 JAPANFull name of second inventor Katsumi SUZUKI

Inventor's Signature

Katsumi Suzuki

Date

November 25, 2005Residence Kawasaki-shi, Kanagawa-ken, JAPAN

Citizenship

JapaneseMailing Address 548, Kuji, Takatsu-ku, Kawasaki-shi, Kanagawa-ken 213-0032 JAPAN☒ Additional inventors are being named on separately numbered sheets attached hereto.

Form (Rev. 2/01)

UNITED STATES

Docket No.:

COMBINED DECLARATION/POWER OF ATTORNEY FOR UTILITY/DESIGN PATENT APPLICATION

Full name of third inventor Toshinori SHIRAKI

Inventor's Signature Toshinori Shiraki Date November 25, 2005
Residence Yamato-shi, Kanagawa-ken, JAPAN Citizenship Japanese
Mailing Address 2-16-14, Sakuramori, Yamato-shi, Kanagawa-ken 242-0028, JAPAN

Full name of fourth inventor Jae Yeon LEE

Inventor's Signature [Signature] Date 25/NOV/2005
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Full name of fifth inventor Jun Choi PIL

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Full name of sixth inventor Suk Hun SUR

Inventor's Signature [Signature] Date 25/Nov/2005
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Full name of seventh inventor Dae Shik KIM

Inventor's Signature [Signature] Date 25/Nov/2005
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Mailing Address Dskim@kifit.re.kr 464-4 Bu Am Dong, Jin Gu, Busan 614-093 KOREA

Full name of eighth inventor _____

Inventor's Signature _____ Date _____
Residence _____ Citizenship _____
Mailing Address _____

Full name of ninth inventor _____

Inventor's Signature _____ Date _____
Residence _____ Citizenship _____
Mailing Address _____